

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

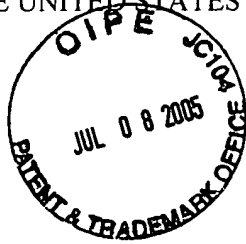
In re application of

Mizuki NAGAI et al.

Serial No. 10/664,078

Filed September 17, 2003

COPPER-PLATING LIQUID, PLATING
METHOD AND PLATING APPARATUS



: **Confirmation No. 5067**

: Docket No. 2003_1338

: Group Art Unit 1753

: Examiner Edna Wong

Mail Stop: Amendment

PETITION FOR EXTENSION OF TIME

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Petition hereby is made for a three month extension of time to respond to the communication of
January 11, 2005.

The fee of \$1,020.00 is

☒ submitted herewith.

☐ to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is
enclosed.

☐ Small entity status of this application is established by a Small Entity Status Assertion
which

☐ is enclosed.

☐ has been previously submitted.

07/12/2005 HALI11 00000100 10664078

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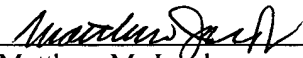
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Respectfully submitted,

Mizuki NAGAI et al.

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

By


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July 8, 2005